

# Sensitivity Analysis of CPP'S for Solvent Removal Process of an API- Polymer Based Nano-suspension

Teva Pharmachemie, Generic R&D Haarlem, The Netherlands

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## **What do we do:**

World's leading generic medicine maker  
Headquarter in Israel

## **Teva Haarlem:**

1946 founded as Pharmachemie  
1998 acquired by Teva

## **Products:**

Dry powder inhalation capsules  
Cytostatic injectables  
Complex sterile products



## Basic unit operation

Emulsification

Solvent removal

Particle size engineering

Filtration

Concentration

Drying

Cristalizatoin

Filling





Failure of Engineering Batch



Sterile Filtration Blockage

Product out of specification



Root cause analysis

Slow solvent removal



API precipitation

Filter blockage



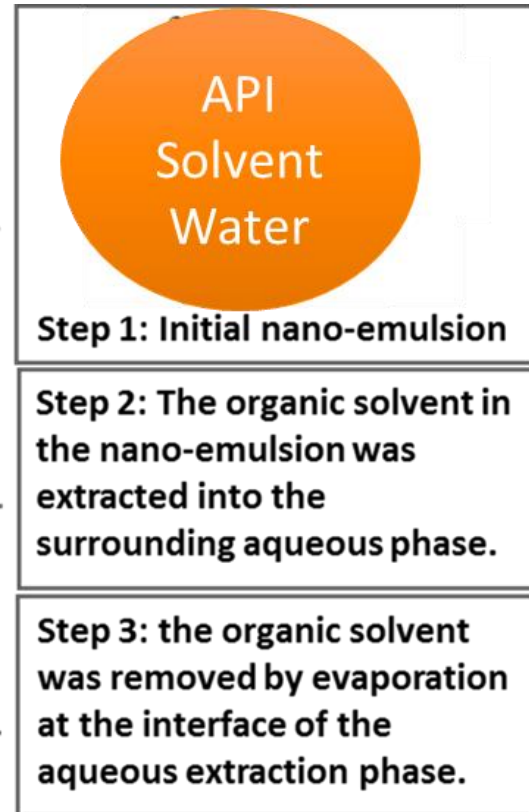
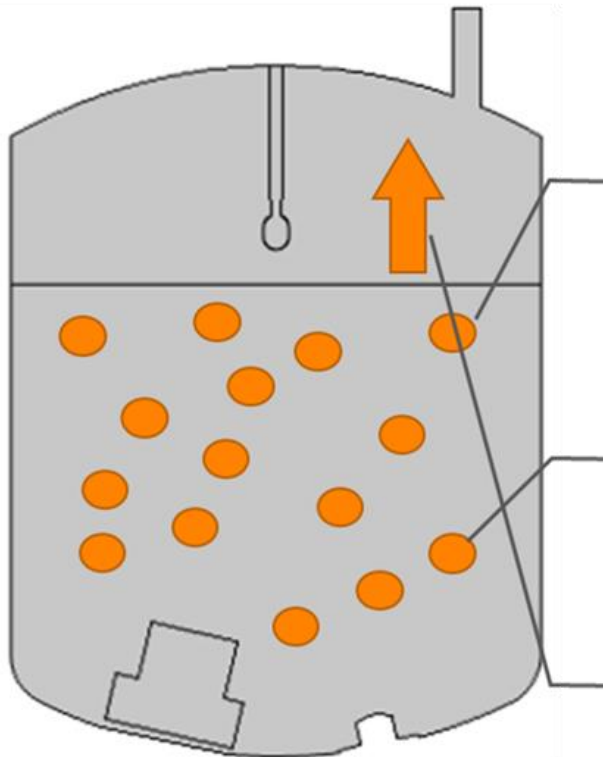


## Criticals Process Parameters

1. Temperature
2. Surface area
3. Agitation
4. Pressure
5. Air flow rate

## Constraints:

- ❖ High temperature-> product degradation
- ❖ High mixing speed-> Dissociation API-polymer and foaming
- ❖ Low solvent removal rate-> API precipitation





- 1
- 2
- 3
- 4
- 5

- Sparging
- New air distribution system
- Vacuum
- Temperature
- Mixing speed

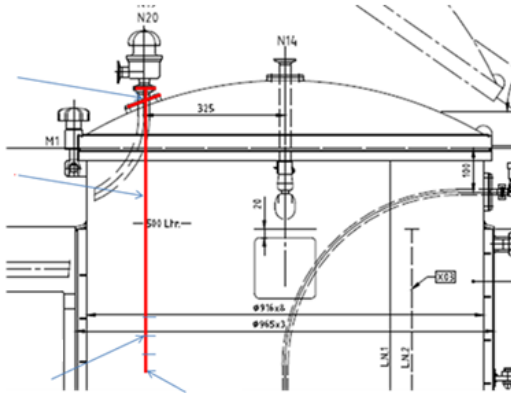
Ring ventilation?



Temperature increase?



Sparger?



Vacuum?





Process Parameters	Settings	Tolerance
Temperature [°C]	20-25	±2
Agitation speed [rpm]	200-300	±50
Air flow rate [L/min]	300-500	±50
pH	6.5-7.5	±1
Particles size distribution [nm]	95-115	±15
Foam formation on surface		

1. What are the impact of these variations on the solvent removal rate?
2. In a worst case senario, how does it compromize the product quality?

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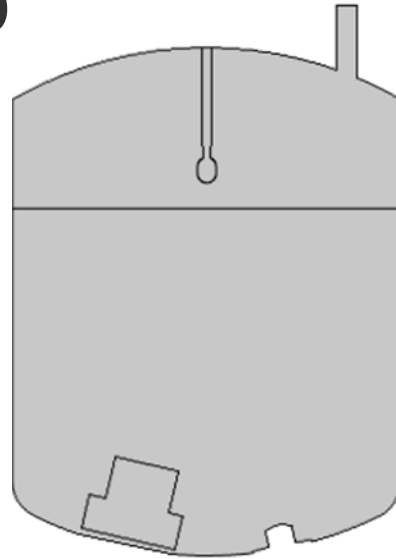
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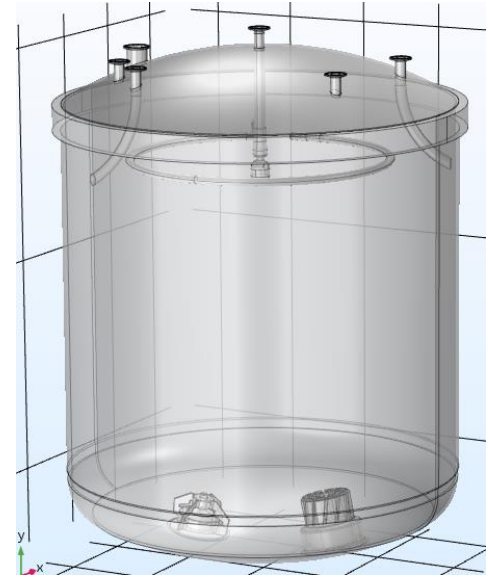




**2D**



**3D**

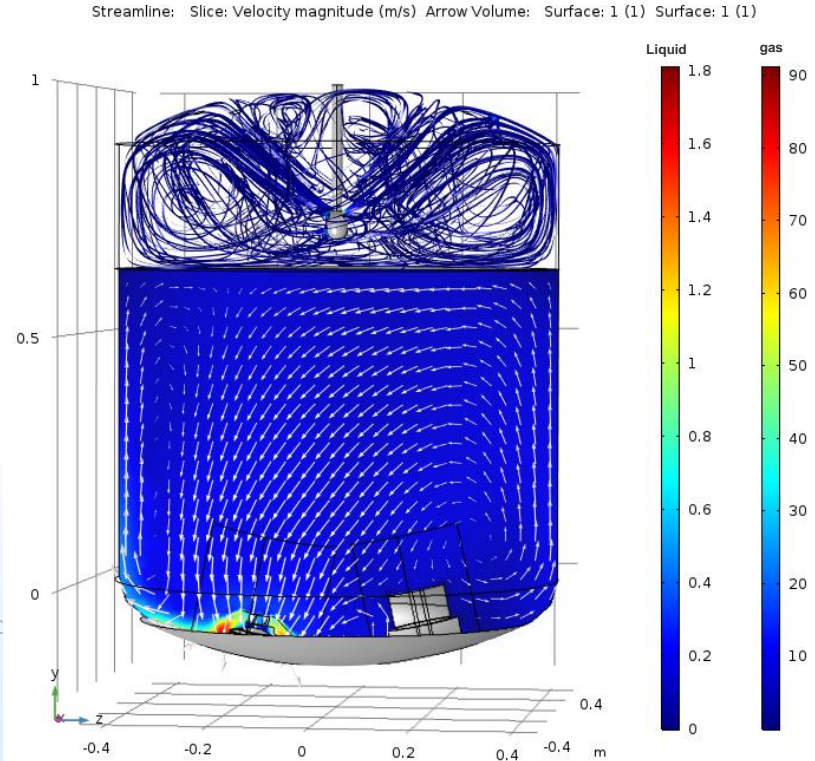
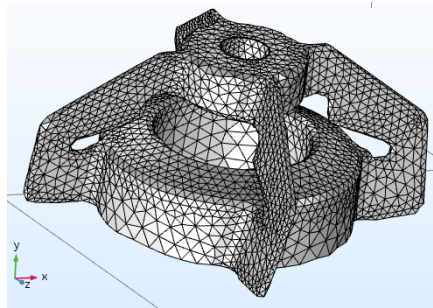


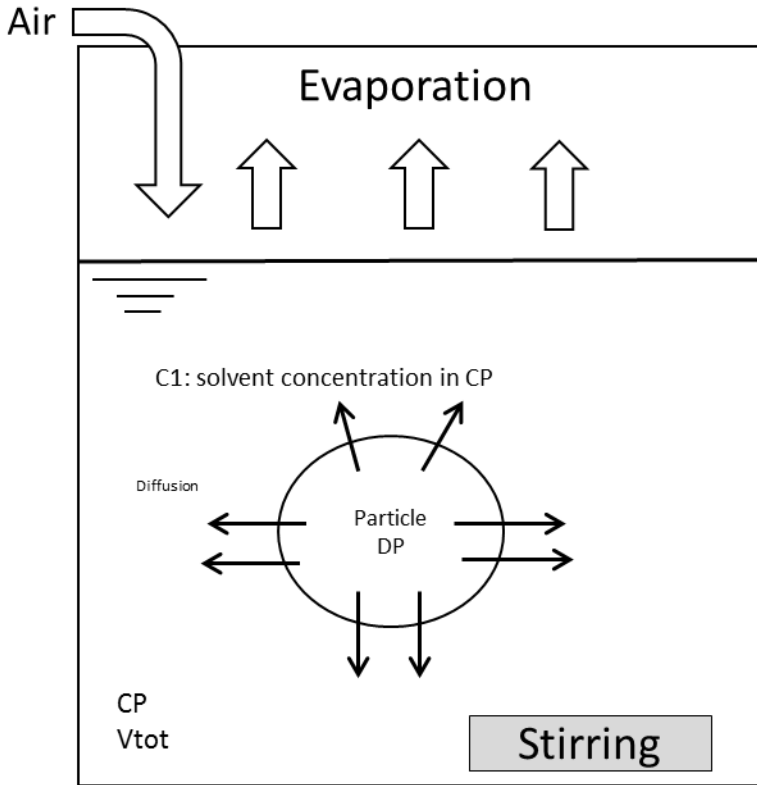


## 2D and 3D Stationary RANS simulation Turbulent $k - \epsilon$ model

$$\rho \left( \frac{\partial u}{\partial t} + u \nabla u \right) = -\nabla p + \nabla (\mu (\nabla u + (\nabla u)^T)) - \frac{2}{3} \mu (\nabla u) I + F$$

$$\frac{\partial \rho}{\partial t} + \nabla (\rho u) = 0$$





Diffusion and convection of the solvent in the gas and liquid phase

$$\frac{\partial c_i}{\partial t} + \nabla \cdot (-D_i \nabla c_i + u c_i) = R_i$$

Diffusion of the solvent in the nanoparticle

$$\frac{\partial c_i}{\partial t} + \nabla \cdot (-D_{part} * \nabla C_{part}) = 0$$

Flux of the solvent at gas/liquid interface

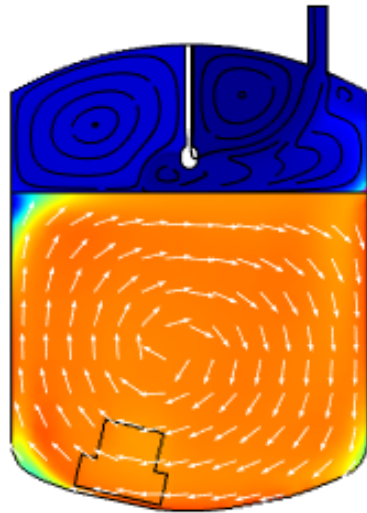
$$m_{evap} = x_{solvent} A_{spec} K_{evap} \left( \frac{P_{sat}}{RT} \right)$$

Flux of the solvent through the nanoparticle/liquid interface

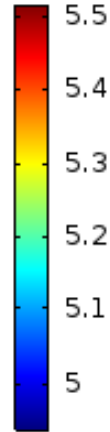
$$m_{part} = A_{tot} k_{part} (C_{part}^e - C_{liq})$$



Concentration profile of the solvent in the liquid and in the gas phase

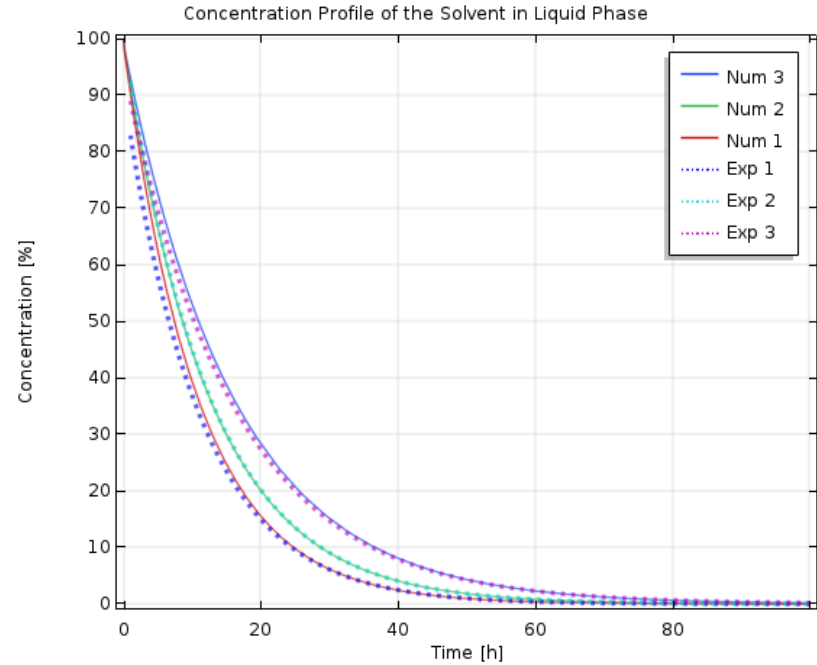
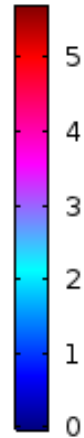


Liquid

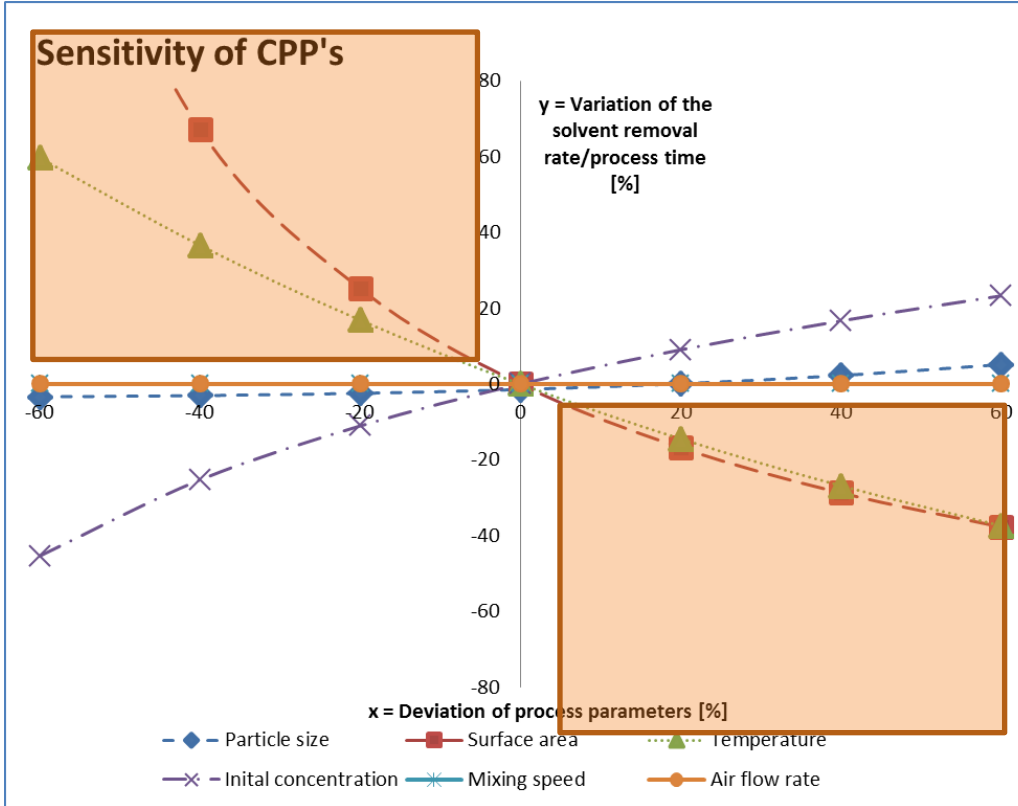


Gas

$\times 10^{-3}$



The model shows good fit to the experimental data.



1. Temperature and the surface area are the most critical process parameters

2. Mixing speed and air flow rate do not have any impact within 60% of the variation.

3. PSD has slightly impact



## Improvements

- Identified CPP's and quantified their impacts
- Process understanding and the control strategy
- Reduce the risks for the process change
- Improved decision making and scale up strategy



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your  
life*

**Thank you  
Q&A**

